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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	F²MC-16LX
Core Size	16-Bit
Speed	16MHz
Connectivity	CANbus, SCI, UART/USART
Peripherals	POR, WDT
Number of I/O	36
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	3.5V ~ 5.5V
Data Converters	A/D 8x8/10b
Oscillator Type	External
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	48-LQFP
Supplier Device Package	48-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/mb90f387spmt-g

Pin No.	Pin Name	Circuit Type	Function
39	P42	D	General-purpose input/output port.
	SOT1		Serial data input pin for UART. Valid only when serial data input/output setting on UART is “enabled.”
40	P43	D	General-purpose input/output port.
	TX		Transmission output pin for CAN. Valid only when output setting is “enabled.”
41	P44	D	General-purpose input/output port.
	RX		Transmission output pin for CAN. Valid only when output setting is “enabled.”
42 to 45	P30 to P33	D	General-purpose input/output ports.
46	X0A*	A	Pin for low-rate oscillation.
	P35*		General-purpose input/output port.
47	X1A*	A	Pin for low-rate oscillation.
	P36*		General-purpose input/output port.
48	AVss	–	Vss power source input pin for A/D converter.

*: MB90387, MB90F387: X1A, X0A
MB90387S, MB90F387S: P36, P35

10. I/O Map

Address	Register Abbreviation	Register	Read/ Write	Resource	Initial Value
000000H	(Reserved area) *				
000001H	PDR1	Port 1 data register	R/W	Port 1	XXXXXXXXB
000002H	PDR2	Port 2 data register	R/W	Port 2	XXXXXXXXB
000003H	PDR3	Port 3 data register	R/W	Port 3	XXXXXXXXB
000004H	PDR4	Port 4 data register	R/W	Port 4	XXXXXXXXB
000005H	PDR5	Port 5 data register	R/W	Port 5	XXXXXXXXB
000006H to 000010H	(Reserved area) *				
000011H	DDR1	Port 1 direction data register	R/W	Port 1	00000000B
000012H	DDR2	Port 2 direction data register	R/W	Port 2	00000000B
000013H	DDR3	Port 3 direction data register	R/W	Port 3	000X0000B
000014H	DDR4	Port 4 direction data register	R/W	Port 4	XXX00000B
000015H	DDR5	Port 5 direction data register	R/W	Port 5	00000000B
000016H to 00001AH	(Reserved area) *				
00001BH	ADER	Analog input permission register	R/W	8/10-bit A/D converter	11111111B
00001CH to 000025H	(Reserved area) *				
000026H	SMR1	Serial mode register 1	R/W	UART1	00000000B
000027H	SCR1	Serial control register 1	R/W, W		00000100B
000028H	SIDR1/ SODR1	Serial input data register 1/ Serial output data register 1	R, W		XXXXXXXXB
000029H	SSR1	Serial status data register 1	R, R/W		00001000B
00002AH	(Reserved area) *				
00002BH	CDCR1	Communication prescaler control register 1	R/W	UART1	0XXX0000B
00002CH to 00002FH	(Reserved area) *				
000030H	ENIR	DTP/External interrupt permission register	R/W	DTP/External interrupt	00000000B
000031H	EIRR	DTP/External interrupt permission register	R/W		XXXXXXXXB
000032H	ELVR	Detection level setting register	R/W		00000000B
000033H			R/W		00000000B
000034H	ADCS	A/D control status register	R/W	8/10-bit A/D converter	00000000B
000035H			R/W, W		00000000B
000036H	ADCR	A/D data register	W, R		XXXXXXXXB
000037H			R		00101XXXB

Address	Register Abbreviation	Register	Read/ Write	Resource	Initial Value
000083H	(Reserved area) *				
000084H	TCANR	Send cancel register	W	CAN controller	00000000B
000085H	(Reserved area) *				
000086H	TCR	Send completion register	R/W	CAN controller	00000000B
000087H	(Reserved area) *				
000088H	RCR	Receive completion register	R/W	CAN controller	00000000B
000089H	(Reserved area) *				
00008AH	RRTRR	Receive RTR register	R/W	CAN controller	00000000B
00008BH	(Reserved area) *				
00008CH	ROVRR	Receive overrun register	R/W	CAN controller	00000000B
00008DH	(Reserved area) *				
00008EH	RIER	Receive completion interrupt permission register	R/W	CAN controller	00000000B
00008FH to 00009DH	(Reserved area) *				
00009EH	PACSR	Address detection control register	R/W	Address matching detection function	00000000B
00009FH	DIRR	Delay interrupt request generation/ release register	R/W	Delay interrupt generation module	XXXXXXX0B
0000A0H	LPMCR	Lower power consumption mode control register	W,R/W	Lower power consumption mode	00011000B
0000A1H	CKSCR	Clock selection register	R,R/W	Clock	11111100B
0000A2H to 0000A7H	(Reserved area) *				
0000A8H	WDTC	Watchdog timer control register	R,W	Watchdog timer	XXXXX111B
0000A9H	TBTC	Time-base timer control register	R/W,W	Time-base timer	1XX00100B
0000AAH	WTC	Watch timer control register	R,R/W	Watch timer	1X001000B
0000ABH to 0000ADH	(Reserved area) *				
0000AEH	FMCS	Flash memory control status register	R,W,R/W	512k-bit Flash memory	000X0000B
0000AFH	(Reserved area) *				

Address	Register Abbreviation	Register	Read/ Write	Resource	Initial Value
0000B0H	ICR00	Interrupt control register 00	R/W	Interrupt controller	00000111B
0000B1H	ICR01	Interrupt control register 01			00000111B
0000B2H	ICR02	Interrupt control register 02			00000111B
0000B3H	ICR03	Interrupt control register 03			00000111B
0000B4H	ICR04	Interrupt control register 04			00000111B
0000B5H	ICR05	Interrupt control register 05			00000111B
0000B6H	ICR06	Interrupt control register 06			00000111B
0000B7H	ICR07	Interrupt control register 07			00000111B
0000B8H	ICR08	Interrupt control register 08			00000111B
0000B9H	ICR09	Interrupt control register 09			00000111B
0000BAH	ICR10	Interrupt control register 10			00000111B
0000BBH	ICR11	Interrupt control register 11			00000111B
0000BCH	ICR12	Interrupt control register 12			00000111B
0000BDH	ICR13	Interrupt control register 13			00000111B
0000BEH	ICR14	Interrupt control register 14			00000111B
0000BFH	ICR15	Interrupt control register 15			00000111B
0000C0H to 0000FFH	(Reserved area) *				
001FF0H	PADR0	Detection address setting register 0 (low-order)	R/W	Address matching detection function	XXXXXXXXB
001FF1H		Detection address setting register 0 (middle-order)			XXXXXXXXB
001FF2H		Detection address setting register 0 (high-order)			XXXXXXXXB
001FF3H	PADR1	Detection address setting register 1 (low-order)	R/W		XXXXXXXXB
001FF4H		Detection address setting register 1 (middle-order)			XXXXXXXXB
001FF5H		Detection address setting register 1 (high-order)			XXXXXXXXB
003900H	TMR0/ TMRLR0	16-bit timer register 0/16-bit reload register	R,W	16-bit reload timer 0	XXXXXXXXB
003901H					XXXXXXXXB
003902H	TMR1/ TMRLR1	16-bit timer register 1/16-bit reload register	R,W	16-bit reload timer 1	XXXXXXXXB
003903H					XXXXXXXXB
003904H to 00390FH	(Reserved area) *				

Address	Register Abbreviation	Register	Read/ Write	Resource	Initial Value
003D0D$_H$	(Reserved area) *				
003D0E$_H$	TIER	Send completion interrupt permission register	R/W	CAN controller	00000000$_B$
003D0F$_H$	(Reserved area) *				
003D10$_H$, 003D11$_H$	AMSR	Acceptance mask selection register	R/W	CAN controller	XXXXXXXX$_B$, XXXXXXXX$_B$
003D12$_H$, 003D13$_H$	(Reserved area) *				
003D14$_H$ to 003D17$_H$	AMR0	Acceptance mask register 0	R/W	CAN controller	XXXXXXXX$_B$ to XXXXXXXX$_B$
003D18$_H$ to 003D1B$_H$	AMR1	Acceptance mask register 1	R/W		XXXXXXXX$_B$ to XXXXXXXX$_B$
003D1C$_H$ to 003DFF$_H$	(Reserved area) *				
003E00$_H$ to 003EFF$_H$	(Reserved area) *				
003FF0$_H$ to 003FFF$_H$	(Reserved area) *				

Initial values:

0: Initial value of this bit is “0.”

1: Initial value of this bit is “1.”

X: Initial value of this bit is undefined.

*: “Reserved area” should not be written anything. Result of reading from “Reserved area” is undefined.

Interrupt Source	EI²OS Readiness	Interrupt Vector			Interrupt Control Register		Priority*3
		Number		Address	ICR	Address	
UART1 reception completed	◎	#37	25H	FFFF68H	ICR13	0000BDH*1	High
UART1 transmission completed	Δ	#38	26H	FFFF64H			↑
Reserved	×	#39	27H	FFFF60H	ICR14	0000BEH*1	
Reserved	×	#40	28H	FFFF5CH			
Flash memory	×	#41	29H	FFFF58H	ICR15	0000BFH*1	↓
Delay interrupt generation module	×	#42	2AH	FFFF54H			Low

○ : Available

× : Unavailable

◎ : Available EI²OS function is provided.

Δ: Available when a cause of interrupt sharing a same ICR is not used.

*1:

- ❒ Peripheral functions sharing an ICR register have the same interrupt level.
- ❒ If peripheral functions share an ICR register, only one function is available when using expanded intelligent I/O service.
- ❒ If peripheral functions share an ICR register, a function using expanded intelligent I/O service does not allow interrupt by another function.

*2: Input capture 1 corresponds to EI²OS, however, PPG does not. When using EI²OS by input capture 1, interrupt should be disabled for PPG.

*3:Priority when two or more interrupts of a same level occur simultaneously.

12. Peripheral Resources

12.1 I/O Ports

The I/O ports are used as general-purpose input/output ports (parallel I/O ports). The MB60385 series model is provided with 5 ports (34 inputs). The ports function as input/output pins for peripheral functions also.

I/O Port Functions

An I/O port, using port data resister (PDR), outputs the output data to I/O pin and input a signal input to I/O port. The port direction register (DDR) specifies direction of input/output of I/O pins on a bit-by-bit basis.

The following summarizes functions of the ports and sharing peripheral functions:

■ Port 1: General-purpose input/output port, used also for PPG timer output and input capture inputs.

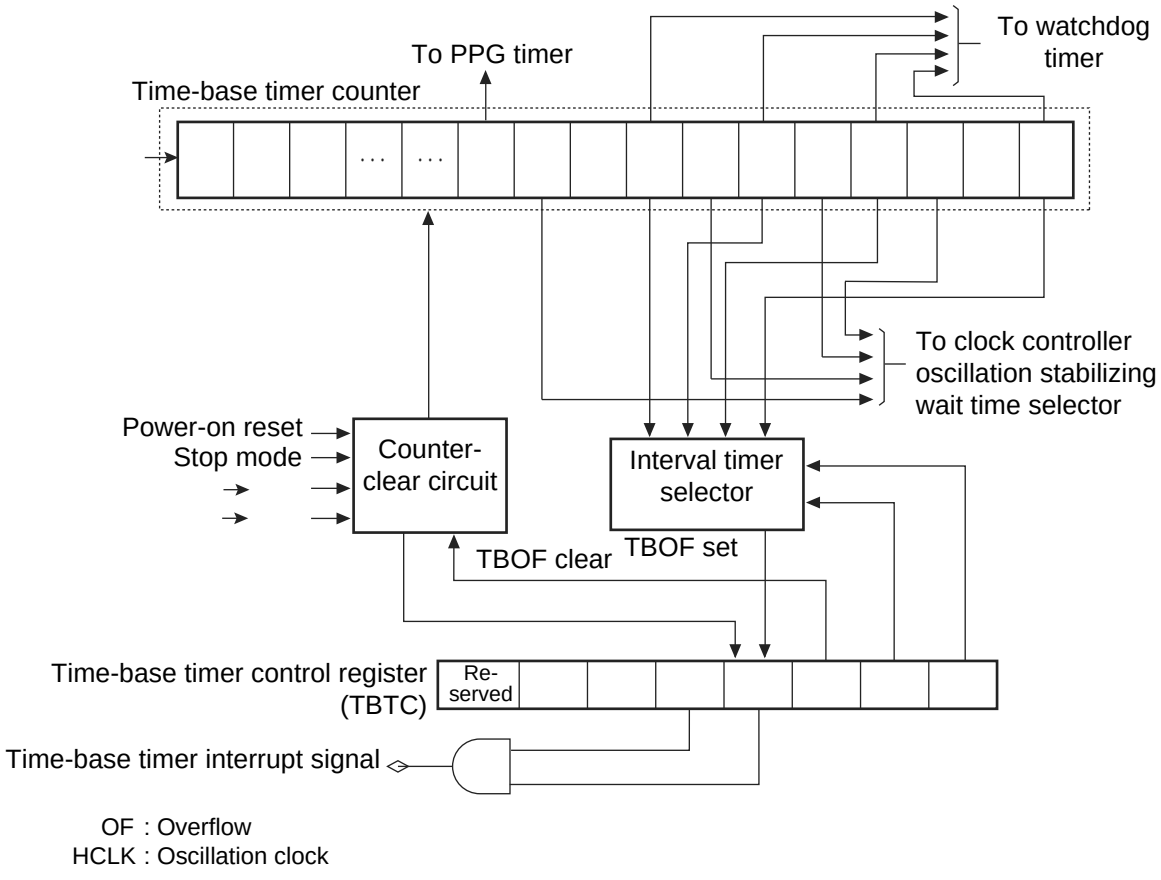
■ Port 2: General-purpose input/output port, used also for reload timer input/output and external interrupt input.

■ Port 3: General-purpose input/output port, used also for A/D converter activation trigger pin.

■ Port 4: General-purpose input/output port, used also for UART input/output and CAN controller send/receive pin.

■ Port 5: General-purpose input/output port, used also analog input pin.

Time-base Timer Block Diagram



OF : Overflow
HCLK : Oscillation clock

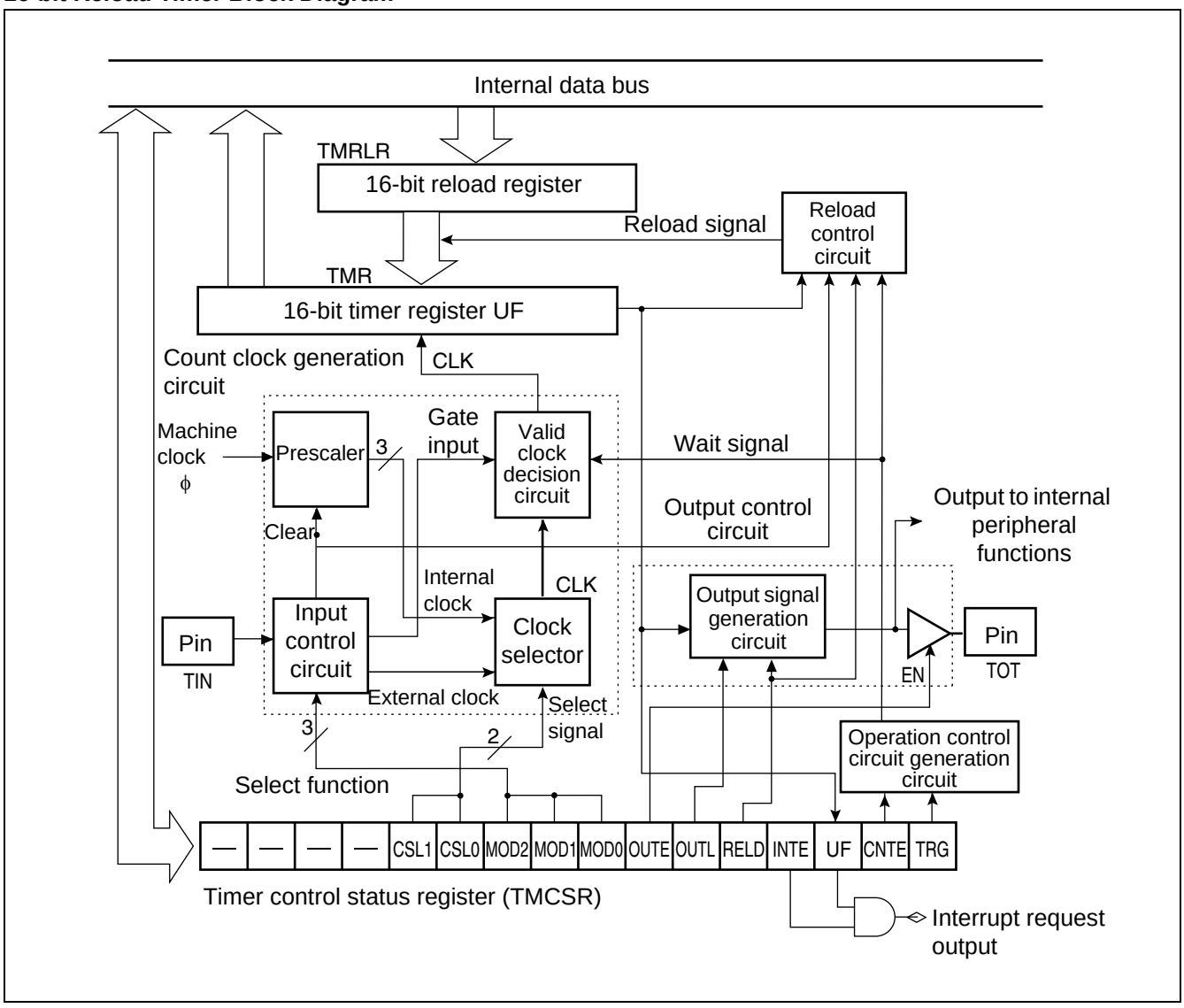
*1: Switch machine clock from main clock to PLL clock.

*2: Switch machine clock from sub clock to main clock.

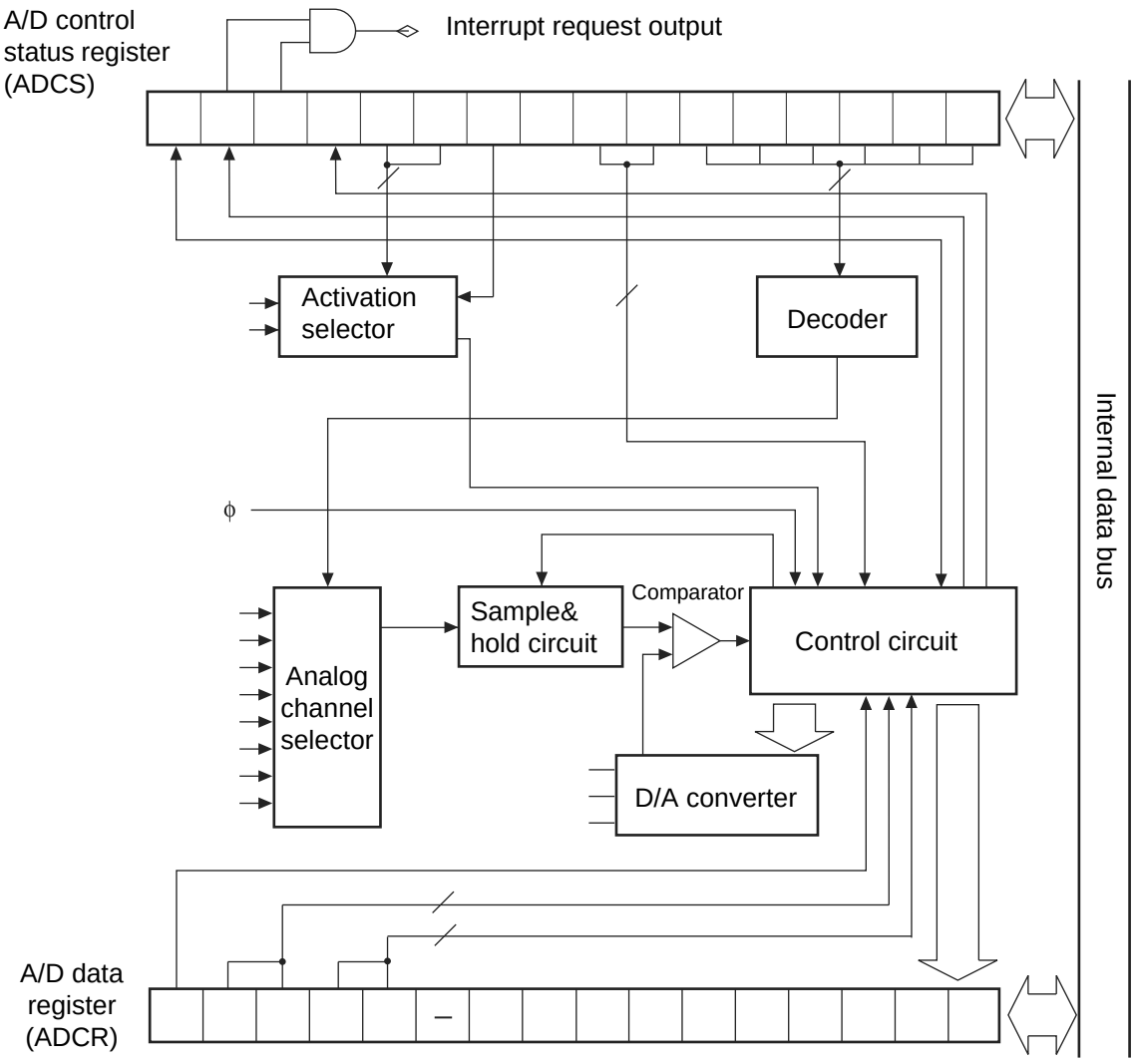
Actual interrupt request number of time-base timer is as follows:

Interrupt request number: #16 (10_H)

16-bit Reload Timer Block Diagram

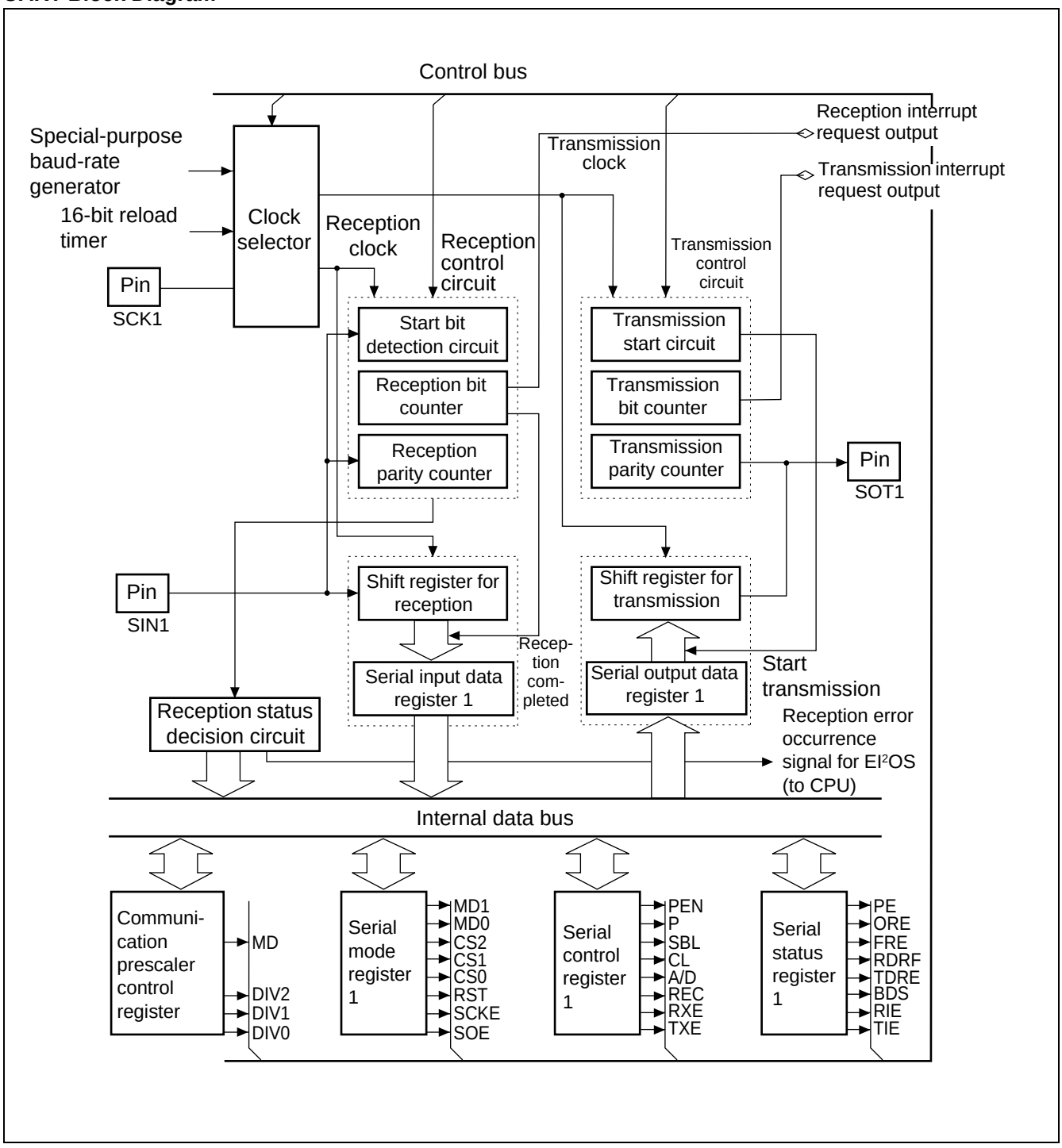


8/10-bit A/D Converter Block Diagram



TO : Internal timer output
– : Not defined
Reserved: Be sure to set to “0”
ϕ : Machine clock

UART Block Diagram



12.15 512 Kbit Flash Memory Outline

The following three methods are provided for data writing and deleting on Flash memory:

1. Parallel writer
2. Serial special-purpose writer
3. Writing/deleting by program execution

This section describes “3. Writing/deleting by program execution.”

512 Kbit Flash Memory Outline

The 512 Kbit Flash memory is allocated on FF_H bank of CPU memory map. Using the function of Flash memory interface circuit, the memory allows read access and program access from CPU.

Writing/deleting on Flash memory is performed by instruction from CPU via Flash memory interface. Because rewriting is allowed on mounted memory, modifying program and data is performed efficiently.

Features of 512 Kbit Flash Memory

- 128 K words x 8 bits/64 K words x 16 bits (16 K + 8 K + 8 K + 32 K) sector configuration
- Automatic program algorithm (Embedded Algorithm: Similar to MBM29LV200.)
- Built-in deletion pause/deletion resume function
- Detection of completed writing/deleting by data polling and toggle bits.
- Detection of completed writing/deleting by CPU interrupt.
- Deletion is allowed on a sector-by-sector basis (sectors are combined freely).
- Number of writing/deleting operations (minimum): 10,000 times
- Sector protection
- Expanded sector protection
- Temporaly sector unprotection

Note: A function of reading manufacture code and device code is not provided. These codes are not accessible by command either.

Flash Memory Writing/Deleting

- Writing and reading data is not allowed simultaneously on the Flash memory.
- Data writing and deleting on the Flash memory is performed by the processes as follows: Make a copy of program on Flash memory onto RAM. Then, execute the program copied on the RAM.

List of Registers and Reset Values in Flash Memory

Flash memory control status register (FMCS)

bit	7	6	5	4	3	2	1	0
	0	0	0	X	0	0	0	0

× : Undefined

Sector Configuration

For access from CPU, SA0 to SA3 are allocated in FF bank register.

Sector Configuration of 512 Kbit Flash Memory

Flash memory	CPU address	Writer address*
SA0 (32 Kbytes)	FF0000H FF7FFFH	70000H 77FFFH
SA1 (8 Kbytes)	FF8000H FF9FFFH	78000H 79FFFH
SA2 (8 Kbytes)	FFA000H FFBFFFH	7A000H 7BFFFH
SA3 (16 Kbytes)	FFC000H FFFFFFH	7C000H 7FFFFH

*: “Writer address” is an address equivalent to CPU address, which is used when data is written on Flash memory, using parallel writer. When writing/deleting data with general-purpose writer, the writer address is used for writing and deleting.

13. Electrical Characteristics

13.1 Absolute Maximum Rating

Parameter	Symbol	Rating		Unit	Remarks
		Min	Max		
Power supply voltage*1	V_{CC}	V_{SS} – 0.3	V_{SS} + 6.0	V	
	AV_{CC}	V_{SS} – 0.3	V_{SS} + 6.0	V	$V_{CC} = AV_{CC}$*2
	AVR	V_{SS} – 0.3	V_{SS} + 6.0	V	$AV_{CC} \geq AVR$*2
Input voltage*1	V_I	V_{SS} – 0.3	V_{SS} + 6.0	V	*3
Output voltage*1	V_O	V_{SS} – 0.3	V_{SS} + 6.0	V	*3
Maximum clamp current	I_{CLAMP}	– 2.0	+ 2.0	mA	*7
Total maximum clamp current	$\Sigma \mid I_{CLAMP} \mid$	–	20	mA	*7
“L” level maximum output current	I_{OL1}	–	15	mA	Normal output*4
	I_{OL2}	–	40	mA	High-current output*4
“L” level average output current	I_{OLAV1}	–	4	mA	Normal output*5
	I_{OLAV2}	–	30	mA	High-current output*5
“L” level maximum total output current	ΣI_{OL1}	–	125	mA	Normal output
	ΣI_{OL2}	–	160	mA	High-current output
“L” level average total output current	ΣI_{OLAV1}	–	40	mA	Normal output*6
	ΣI_{OLAV2}	–	40	mA	High-current output*6
“H” level maximum output current	I_{OH1}	–	–15	mA	Normal output*4
	I_{OH2}	–	–40	mA	High-current output*4
“H” level average output current	I_{OHAV1}	–	–4	mA	Normal output*5
	I_{OHAV2}	–	–30	mA	High-current output*5
“H” level maximum total output current	ΣI_{OH1}	–	–125	mA	Normal output
	ΣI_{OH2}	–	–160	mA	High-current output
“H” level average total output current	ΣI_{OHAV1}	–	–40	mA	Normal output*6
	ΣI_{OHAV2}	–	–40	mA	High-current output*6
Power consumption	P_D	–	245	mW	
Operating temperature	T_A	–40	+105	°C	
Storage temperature	Tstg	–55	+150	°C	

*1: The parameter is based on $V_{SS} = AV_{SS} = 0.0$ V.

*2: AVcc and AVR should not exceed Vcc.

*3: V_I and V_O should not exceed Vcc + 0.3 V. However if the maximum current to/from an input is limited by some means with external components, the I_{CLAMP} rating supersedes the V_I rating.

*4: A peak value of an applicable one pin is specified as a maximum output current.

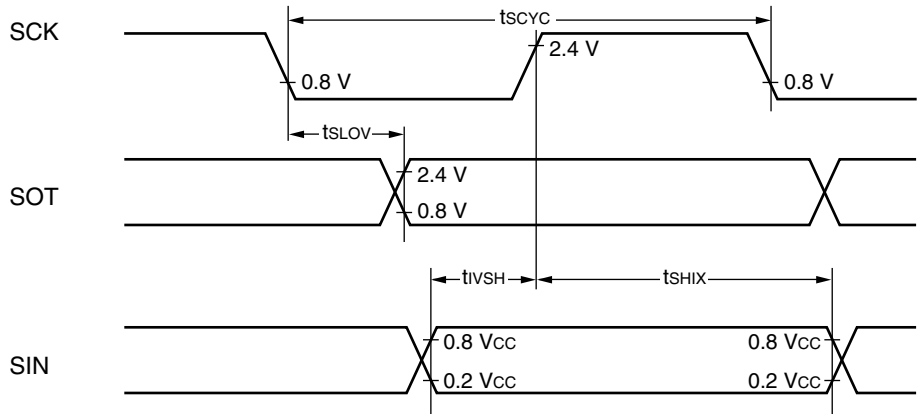
*5: An average current value of an applicable one pin within 100 ms is specified as an average output current. (Average value is found by multiplying operating current by operating rate.)

*6: An average current value of all pins within 100 ms is specified as an average total output current. (Average value is found by multiplying operating current by operating rate.)

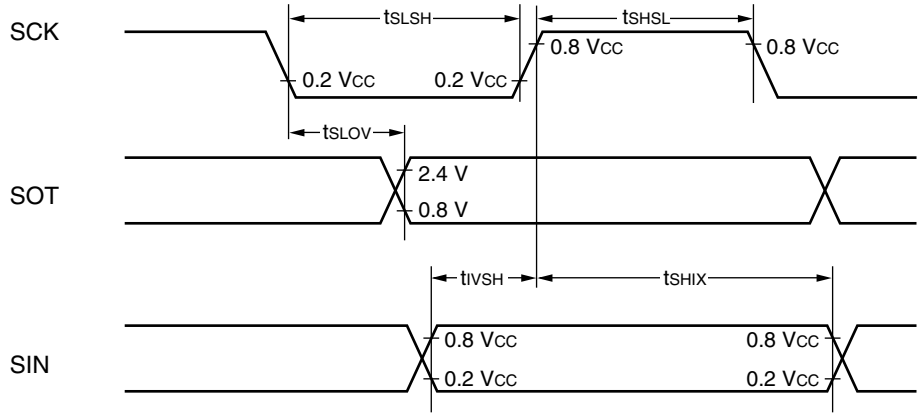
*7:

■ Applicable to pins: P10 to P17, P20 to P27, P30 to P33, P35*, P36*, P37, P40 to P44, P50 to P57
*: P35 and P36 are MB90387S and MB90F387S only.

• Internal shift clock mode



• External shift clock mode



13.4.5 Timer Input Timing

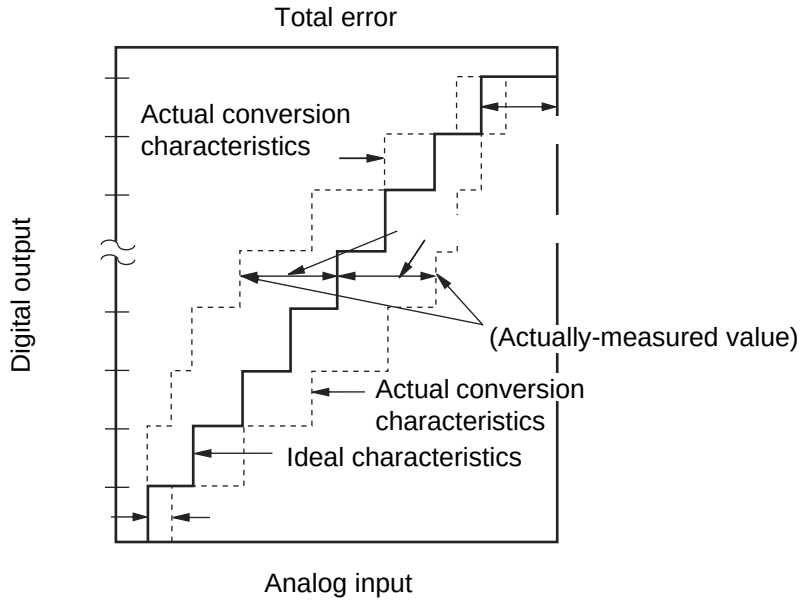
(V_{CC} = 4.5 V to 5.5 V, V_{SS} = 0.0 V, T_A = −40 °C to +105 °C)

Parameter	Symbol	Pin Name	Conditions	Value		Unit	Remarks
				Min	Max		
Input pulse width	t_{TIWH}	TIN0, TIN1	–	4 t_{CP} *	–	ns	
	t_{TIWL}	IN0 to IN3					

*: Refer to Clock Timing ratings for t_{CP} (internal operation clock cycle time).

13.6 Definition of A/D Converter Terms

Resolution:	Analog variation that is recognized by an A/D converter.
Linear error:	Deviation between a line across zero-transition line (“00 0000 00 0 0” ←→“00 0000 0001”) and full-scale transition line (“11 1111 11 1 0” ←→ “11 1111 1111”) and actual conversion characteristics.
Differential linear error:	Deviation of input voltage, which is required for changing output code by 1 LSB, from an ideal value.
Total error:	Difference between an actual value and an ideal value. A total error includes zero transition error, full-scale transition error, and linear error.



$$\text{Total error of digital output “N”} = \frac{V_{NT} - \{1\ \text{LSB} \times (N - 1) + 0.5\ \text{LSB}\}}{1\ \text{LSB}} \quad [\text{LSB}]$$

$$1\ \text{LSB} = (\text{Ideal value})\ \frac{AVR - AV_{SS}}{1024}\ [V]$$

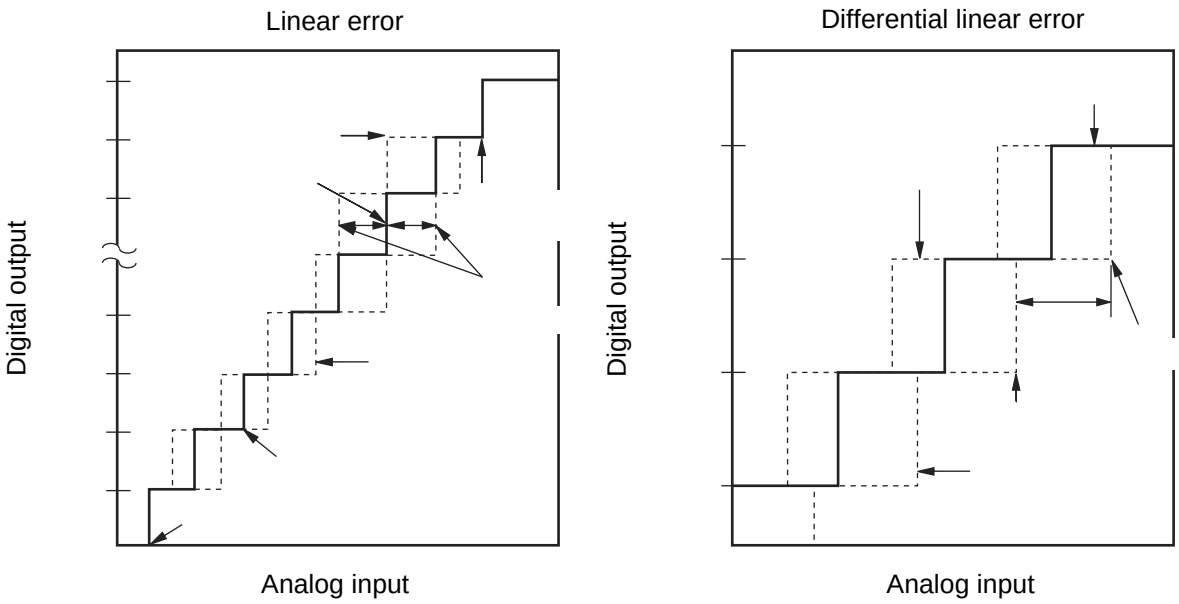
V_{OT} (Ideal value) = AV_{SS} + 0.5 LSB [V]

V_{FST} (Ideal value) = AVR − 1.5 LSB [V]

V_{NT}: A voltage at which digital output transits from $(N\text{-}1)_H$ to N_H.

(Continued)

(Continued)



$$\text{Linear error of digital output N} = \frac{V_{NT} - \{1\ \text{LSB} \times (N - 1) + V_{OT}\}}{1\ \text{LSB}}\ [\text{LSB}]$$

$$\text{Differential linear error of digital output N} = \frac{V_{(N+1)T} - V_{NT}}{1\ \text{LSB}} - 1\text{LSB}\ [\text{LSB}]$$

$$1\ \text{LSB} = \frac{V_{FST} - V_{OT}}{1022}\ [\text{V}]$$

V_{OT}: Voltage at which digital output transits from “000_H” to “001_H.”
V_{FST}: Voltage at which digital output transits from “$3FE_H$” to “$3FF_H$.”

13.7 Notes on A/D Converter Section

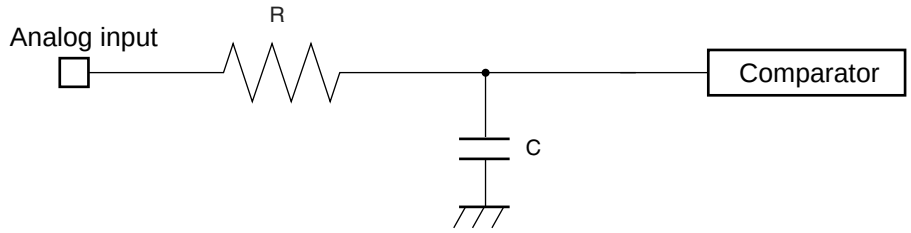
Use the device with external circuits of the following output impedance for analog inputs:

Recommended output impedance of external circuits are: Approx. 3.9 kΩ or lower (4.5 V ≤ AVcc ≤ 5.5 V) (sampling period=2.00 μs at 16 MHz machine clock), Approx. 11 kΩ or lower (4.0 V ≤ AVcc < 4.5 V) (sampling period=8.0 μs at 16 MHz machine clock).

If an external capacitor is used, in consideration of the effect by tap capacitance caused by external capacitors and on-chip capacitors, capacitance of the external one is recommended to be several thousand times as high as internal capacitor.

If output impedance of an external circuit is too high, a sampling period for an analog voltage may be insufficient.

- Analog input circuit model



MB90F387/S, MB90387/S

4.5 V ≤ AV_{CC} ≤ 5.5 V R ≅ 2.35 kΩ, C ≅ 36.4 pF

4.0 V ≤ AV_{CC} < 4.5 V R ≅ 16.4 kΩ, C ≅ 36.4 pF

Note: Use the values in the figure only as a guideline.

About errors

As [AVR-AVss] become smaller, values of relative errors grow larger.

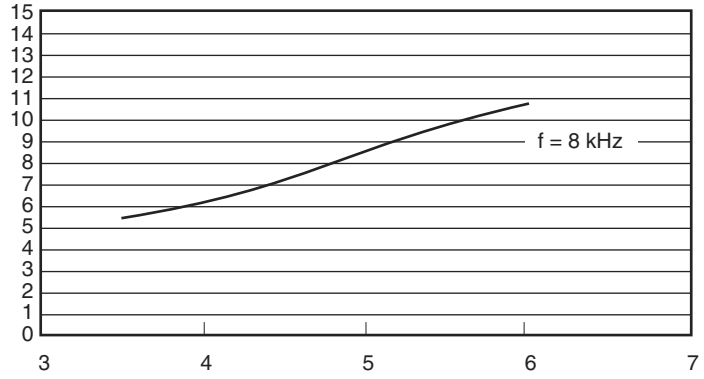
13.8 Flash Memory Program/Erase Characteristics

Parameter	Conditions	Value			Unit	Remarks
		Min	Typ	Max		
Sector erase time	T_A = + 25 °C V_{CC} = 5.0 V	–	1	15	s	Excludes 00H programming prior to erasure
Chip erase time		–	4	–	s	Excludes 00H programming prior to erasure
Word (16-bit width) programming time		–	16	3,600	μs	Except for the over head time of the system
Program/Erase cycle	–	10,000	–	–	cycle	
Flash Data Retention Time	Average T_A = + 85 °C	20	–	–	Year	*

*: This value comes from the technology qualification (using Arrhenius equation to translate high temperature measurements into normalized value at + 85 °C).

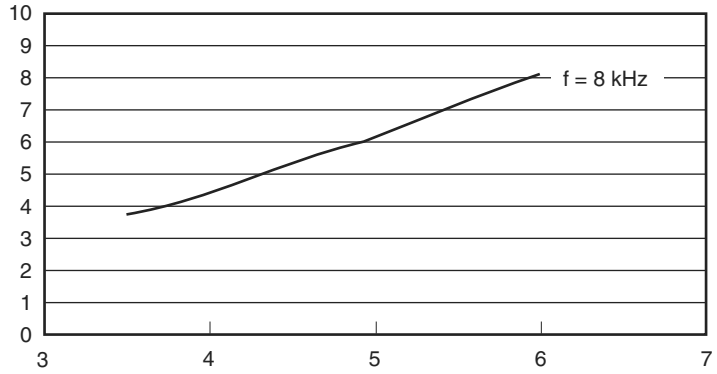
I_{CCLS} – V_{CC}

T_A = +25 °C, In external clock operation
f = Internal operating frequency



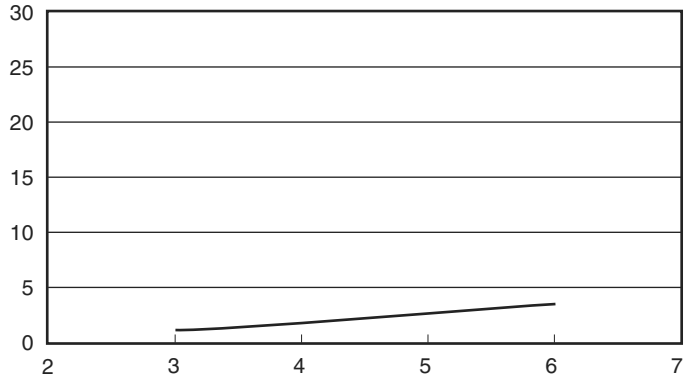
I_{CCT} – V_{CC}

T_A = +25 °C, In external clock operation
f = Internal operating frequency



I_{CCH} – V_{CC}

Stopping, T_A = +25 °C



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Document History

Document Title: MB90387/387S/F387/F387S, MB90V495G, 16-bit Microcontrollers F²MC-16LX MB90385 Series Document Number:002-07765				
Revision	**ECN**	**Orig. of Change**	**Submission Date**	**Description of Change**
**	—	AKIH	12/19/2008	Migrated to Cypress and assigned document number 002-07765. No change to document contents or format.
*A	6059071	SSAS	02/05/2018	Updated to Cypress template Package: FPT-48P-M26 --> LQA048

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